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**OFFICIAL**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Application Serial No. .... 09/785,858  
 Filing Date ..... February 16, 2001  
 Inventor ..... Leiphart, S.  
 Assignee ..... Micron Technology, Inc.  
 Group Art Unit ..... 1753  
 Examiner ..... Cantelmo, G.  
 Attorney's Docket No. .... MI22-1636  
 Title: Method of Forming an Aluminum Comprising Line Having a Titanium Nitride  
 Comprising Layer Thereon

**RESPONSE TO DECEMBER 31, 2001 OFFICE ACTION**

To: Box Non-Fee Amendment  
 Assistant Commissioner for Patents  
 Washington, D.C. 20231  
  
 From: Jennifer J. Taylor, Ph.D. (Tel. 509-624-4276; Fax 509-838-3424)  
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 Spokane, WA 99201-3828

**AMENDMENTS**

**In the Specification**

Please replace the Related Patent Data section on page 1 with the following clean replacement paragraph in accordance with 37 CFR § 1.121(b)(1)(ii):

**--RELATED PATENT DATA**

*B1* This patent resulted from a continuation application of U.S. Patent Application Serial No. 09/378,651, filed August 19, 1999, which issued as U.S. Patent No. 6,224,942 on May 1, 2001, the disclosure of which is incorporated by reference.--